

Component Title:

Bipolar (PN) Power Diodes based on type BYV, BYW and STTH

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Executive Member: **CNES** 

Date: 26/06/2019 274G rev1

Components (includi	ng series and famil	lies) s	ubmitted fo	or Extension	n of Qu	alification /	Approval:					1
ESCC COMPONENT NO.	VARIANTS		RANGE OF COM		MPON	ENTS	BASED ON		)	TEST VEHICLE / S	COMPONEN SIMILAR	١T
5103/029	05, 07, 08	TO254, SMD0.5			BYW81-200			33518002ZW SMD.5				
5103/031 5103/032				TO254, TO254AA   SMD1			BYV54- STTH60			33609 TO254AA ID33621007ZZ SMD1		
5103/033	01, 02, 03		TO254AA SMD1			STTH40			33648007ZZ SMD1			
Component Ma	anufacturer	2	Location of Manufacturing Plant(s				3				4	
STMicroelectronics			3, rue de Suisse BP4199, 35041 Rennes Cedex				Date of original qualification approval:  Date: 01/08/2003  Certificate Ref No. 274					
									Cerui	icate Ref No. 274		
		5	6				6	7				
ESCC Specifications Maintenance of quali			Deviations to LVT testing and Detail Specification used:				on	Qualification Extension Report reference and date:				
Generic: 5000  Detail(s): 5103/02		3 9	No Deviation	<del></del> -2	□ ent Sne	15)	etails in B	ox	BYV	81-200SG Lot ID335118 54S200HYG Lot ID3360 160400SAG3 Lot ID3362	900301_Chart F4 8/1	2/17
5103/031 7 5103/032 1 5103/033 1				Deviation from current Specifications:				4/5/17 Evaluation report STTH60400: RNS/SS/18-024-01 Evaluation report STTH40200: RNS/SS/17-325-01 STTH60200CSAG Lot ID 33648007ZZ_ChartF4_Sg2&3				
			No ☑ Yes ☐ (Supply details) S11H602 29/11/201				648007ZZ_ChartF4_S	Sg2&3				
	Nigotion (			***************************************								8
Summary of procurement or equivalent test r								plicatio		100 V/2		
Project Name Testing Level				LAT			Date code			Quantit	ty Delivered	
12 March 2017 (1970) 12 March 2018 (1970) 12 March	× 800- 10 - 1000 - 10- 10-10											
			İ	of the Section of the	ĺ					THE RESERVE OF THE PROPERTY OF		
										The second secon		т
PID changes since st	art of qualification			9	Curi	rent PID V	erified by:			CNES		10
500000 /0						Ref No: 8097046 (gene			Excutive Representative Agency ric) Rev 21 and 8122351 (specific Power Rectifier and			
Minor* ⊠						Schottky Diode			s) rev 13			u
Major* □ *Provide details in box:					Issue:  Rev Date:					Date	e: 14/10/2018	
					1 1.01	Duto.						11
Current Manufacturing facilities surveyed by:					CNES				on 21/01/2019			
(Ex					cutive Representative Agency)			_		(Date)		
Satisfactory:	Yes 🖂		No	□ Ex	plain							
Report Reference:	CR-Activités	s ST J	anvier 201	9								



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Failure Analysis, DPA, NCCS available: (Supply data) Yes No Ref. No's and purposes: 13 The undersigned hereby certifies on behalf of the ESCC Executive - that the above information is correct; that the appropriate documentation has been evaluated; - that full compliance to all ESCC requirements is evidence (except as stated in box 15;) - that the reports and data are available at the ESCC Executive and therefore applies on behalf of CNES as the responsible Executive Member for ESCC qualification status to be extended to the component(s) listed herein. Date: 16/07/2019 JP BUSSENOT (Signature of the Executive Coordinator) Continuation of Boxes above: 14



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Non comp	pliance to ESCC requirements:			15
No.:	Specification	Paragraph	Non compliance	
Additional noncompl	tasks required to achieve full compliance for	ESCC qualification or rationale for acceptability	of	16
-	Environmental/mechanical subgroup and as TO254 package covered by tests on BYV54 SMD1 packaged covered by test on STPS8 SMD.5 package covered by test on BYV81-Endurance subgroup: All dies have done 20	IS200 in TO254AA 0A150CSAG (see certificate 272) 200SG in SMD.5		
Executive	Manager Disposition	***************************************		17
Applicatio	n Approval: Yes No 🗆			
Action / R	93340		B 101	
Date:			B. Schade: Head of ESA Product Assurance and Safety Department	е



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## ANNEX 1: LIST OF TESTS DONE TO SUPPORT EXTENSION OF QUALIFICATION

Tests conducted in compliance with:

ESCC 5000 generic specification; Chart F4 (for ESCC/QPL parts); or PID-TFD (for ESCC/QML parts)

Tests vehicle identification/description:

BYW81-200SG Lot ID335118002ZW_Chart F4 DC1612	STTH60400CSAG3_Chart F4 Sg2 DC1637
BYV54S200HYG Lot ID3360900301_Chart F4 DC1712	STTH60200CSAG_Chart F4 Sg2&3 DC1711

Detail Specification reference: ... 5103/033

Chart		Tick		Date Code	Tostad	NIO - 6	Comments iftf-
F4	Test	when done	Conditions	Diffusion Lot	Tested Qty	N° of Rejects	Comments if not performed Comments on Rejection
	Mechanical shock	×	MIL-STD-750 TM2016	1612 1712	15 + 15	0	
	Vibration	×	MIL-STD-750 TM2056	1612 1712	15 + 15	0	
	Constant acceleration	×	MIL-STD-750 TM2006	1612 1712	15 + 15	0	
Environmental/Mechanical Subgroup	Seal Fine leak Gross leak	$\boxtimes$	MIL-STD-750 TM1071	1612 1712	15 + 15	0	
	Electrical Measurement	×	Intermediate and End- Point Electrical Measurements	1612 1712	15 + 15	0	
nanic	External Visual	×	ESCC Basic Spec 20500	1612 1712	15 + 15	0	
al/Mech	Thermal shock		MIL-STD-750 TM1056	Click here to enter text.			Only applicable to axial lead glass diodes
nent	Temperature Cycling	$\boxtimes$	MIL-STD-750 TM1051	1612 1712	15 + 15	0	
ironi	Moisture Resistance	×	MIL-STD-750 TM1021	1612 1712	15 + 15	0	
Env	Seal Fine leak Gross leak	×	MIL-STD-750 TM1071	1612 1712	15 + 15	0	
	Electrical Measurement	×	Intermediate and End- Point Electrical Measurements	1612 1712	15 + 15	0	
	External Visual	×	ESCC Basic Spec 20500	1612 1712	15 + 15	0	
Endurance Subgroup	Operating Life	×	ESCC 5000 Para. 8.19	1612 1712 1637 1711	15 + 15 +15 + 15	0	
	Electrical Measurement	×	Intermediate and End- Point Electrical Measurements	1612 1712 1637 1711	15 + 15 +15 + 15	0	
	Seal Fine leak Gross leak	×	MIL-STD-750 TM1071	1612 1712 1637 1711	15 + 15 +15 + 15	0	
	External Visual Inspection	×	ESCC Basic Spec 20500	1612 1712 1637 1711	15 + 15 +15 + 15	0	
Assembly Capability Subgroup	Permanence of Marking		ESCC Basic Spec 24800				Not applicable on Laser marking
	Terminal Strength	×	ESCC 5000 Para. 8.18	1612 1712 1711	5+5+5	0	
	Internal Visual	×	ESCC Basic Spec 20400	1612 1712 1711	5+5+5	0	
Asse	Bond Strength	×	MIL-STD-750 TM 2037	1612 1712 1711	3+3+3	0	

1612 1712 1711 Die Shear  $\boxtimes$ MIL-STD-750 TM 2017 3 + 3 + 3 0



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PLOTE TO THE PROPERTY OF THE PARTY OF THE PA		Executiv	Executive Member: CNES			Date: 26/06/2019 274G-rev1			
Ch art F4	Test	Tick when done	Conditions	Date Code Diffusion Lot	Tested Qty	N° of Rejects	Comm perf Comments o	ents if not formed. on Rejection	
nal									
Additional Tests									
Ğ									
COMMITTEE N	· · · · · · · · · · · · · · · · · · ·								



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## NOTES ON THE COMPLETION OF THE APPLICATION FORM FOR ESCC QUALIFICATION EXTENSION APPROVAL

ENTRIES Form heading	shall indicate: - the title of the component as given in its detail specification or the name of the series, family; - the Executive Member; - the entering date; - the certificate number and its sequential suffix.
Box 1	shall provide details given in the table; in particular there shall be listed: - the variants or range of variants; - the range of components (the ESCC code is recommended to indicate the values or values range, the tolerance, the voltage, etc); the designation given in the detail specification as 'base on'; - under Test Vehicle enter either an ESCC code or the specific characteristic capable of identifying the component tested (e.g., voltage of coil for a relay); - under component similar enter a cross if relevant.
Box 2; 3 and 4	As per QPL entry; otherwise, an explanation of the changes must be supplied.
Box 5	Will show the ESCC Generic and Detail specifications, including issue number and revision letter, current at the time the tests reported were performed. If the specifications are different from those current on the date of the application, see Box 6.
Box 6	Will show the deviations from the Generic and Detail Specifications listed in Box 5, in particular deviations from testing. In case of deviations this must be listed in Box 15. In case the referenced specification in Box 5 have currently a different issue and/or revision indicate also whether the test data deviates or not from such current documents.
Box 7	Must reference the report(s) supplied in support of the application.
Box 8	Should provide the details of procurement to the full ESCC System, documentation of all of which should already have been delivered to the ESCC Executive under the terms of the relevant Generic Specification. An appropriate table has been drawn in this box.
Box 9	If the PID evolved after the Original Qualification or after the last Extension of Qualification, adequate details of such evolution shall be provided together with the reasons for the changes. Major changes shall be clearly marked.
Box 10	Identify the current PID issue status, date and actual date of verification. The date of verification of the current PID should be arranged as close as possible to the required date of extension.
Box 11	This box can be completed only after a physical visit to the plant to confirm that no unexplained changes occurred and that the practices, procedures, material, etc. used in manufacturing the components are as described in the PID. This survey shall be carried out in accordance with the requirements of ESCC Basic Specification No. 20200 and its findings shall be recorded.
Box 12	Provide details of, or reference to, any Destructive Physical Analysis (DPA) and Failure Analysis reports as well as any Nonconformance(s) (NCCS) occurred during the qualification validity period, stating if established corrective action have produced satisfactory results.
Box 13	Enter only the name of the Executive Member (i.e., CNES, DLR, ESTEC, etc.) and the signature of the responsible Executive Coordinator.
Box 14	To be used when there is a need to expand any of the boxes from 1 through 12. Identify box affected and reference the Box 14 in the relevant Box. Box 14 can be broken into 14a, 14b, etc. if several boxes have to be expanded.
Box 15	Fill in Table as requested.
Box 16	Any additional action deemed necessary by the Executive Member to bring the submitted data to a standard likely to be accepted by the ESCC Executive should be listed herein or the reason(s) to accept the noncompliance.
Box 17	All Executive Manager recommendations on the application itself, special conditions or restrictions, modifications of the QPL or QML entry, letters to the manufacturer, etc. shall be entered clearly in Box 19, signed by the representative for ESA, and dated.
Box 18	Fill in Table as requested.
Box 19	Confidential Details of PID changes including those of a confidential nature, shall be provided.
Box 20	State noncompliance with reference to specification(s) and paragraph(s). To simplify reference in Box 16 each nonconformance shall be sequentially numbered. If relevant state 'None'.
Box 21	Any additional action deemed necessary by the Executive Member to bring the submitted data to a standard likely to be accepted by the ESCC Executive should be listed herein or the reason(s) to accept the noncompliance.
Box 22	Additional Comments.